

Title (en)  
A METAL-SEMICONDUCTOR-METAL (MSM) HETEROJUNCTION DIODE

Title (de)  
METALL-HALBLEITER-METALL (MSM)-HETEROÜBERGANGSDIODE

Title (fr)  
DIODE MÉTAL/SEMI-CONDUCTEUR/MÉTAL À HÉTÉROJONCTION

Publication  
**EP 2839509 A2 20150225 (EN)**

Application  
**EP 13778627 A 20130419**

Priority  
• US 201261687163 P 20120419  
• US 2013037358 W 20130419

Abstract (en)  
[origin: WO2013158986A2] In one aspect, a diode comprises: a semiconductor layer having a first side and a second side opposite the first side, the semiconductor layer having a thickness between the first side and the second side, the thickness of the semiconductor layer being based on a mean free path of a charge carrier emitted into the semiconductor layer; a first metal layer deposited on the first side of the semiconductor layer; and a second metal layer deposited on the second side of the semiconductor layer.

IPC 8 full level  
**H01L 29/861** (2006.01); **H01L 21/329** (2006.01)

CPC (source: CN EP KR RU US)  
**H01L 29/0665** (2013.01 - US); **H01L 29/6603** (2013.01 - US); **H01L 29/6609** (2013.01 - US); **H01L 29/66121** (2013.01 - US); **H01L 29/66128** (2013.01 - US); **H01L 29/66136** (2013.01 - US); **H01L 29/66219** (2013.01 - US); **H01L 29/86** (2013.01 - CN KR); **H01L 29/861** (2013.01 - EP US); **H01L 29/872** (2013.01 - CN EP KR US); **H01L 27/0814** (2013.01 - US); **H01L 29/0665** (2013.01 - RU); **H01L 29/6603** (2013.01 - RU); **H01L 29/66128** (2013.01 - RU); **H01L 29/861** (2013.01 - RU); **H10B 63/20** (2023.02 - US)

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

DOCDB simple family (publication)  
**WO 2013158986 A2 20131024; WO 2013158986 A3 20131212; WO 2013158986 A4 20140130**; AU 2013249127 A1 20141009; AU 2013249127 B2 20170216; CA 2868107 A1 20131024; CA 2868107 C 20220726; CA 3159109 A1 20131024; CN 104272464 A 20150107; CN 104272464 B 20170811; EP 2839509 A2 20150225; EP 2839509 A4 20151202; EP 2839509 B1 20200527; ES 2812524 T3 20210317; IL 235076 B 20190331; JP 2015517221 A 20150618; JP 2018110237 A 20180712; JP 6324945 B2 20180516; JP 6648165 B2 20200214; KR 102088629 B1 20200316; KR 20150022766 A 20150304; RU 2014146304 A 20160610; RU 2632256 C2 20171003; US 2015137178 A1 20150521; US 2017162666 A1 20170608; US 9553163 B2 20170124; US 9941382 B2 20180410

DOCDB simple family (application)  
**US 2013037358 W 20130419**; AU 2013249127 A 20130419; CA 2868107 A 20130419; CA 3159109 A 20130419; CN 201380020316 A 20130419; EP 13778627 A 20130419; ES 13778627 T 20130419; IL 23507614 A 20141007; JP 2015507218 A 20130419; JP 2018006176 A 20180118; KR 20147032120 A 20130419; RU 2014146304 A 20130419; US 201314391123 A 20130419; US 201615379422 A 20161214